



NOTES:

- Use TLV70012DDC for 1.2V output instead of 1.8V
- Built on PMP10055 Rev_A AC Stacked PCB
- Ref. Des. > 99 have been added on the board

18V@160mA_{pk}, 100mA_{avg}

12V@100mA_{avg}
600mA for 80msec

3.3V@150mA_{avg}

1.8V@80mA_{peak}, 40mA_{avg}

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